Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Title::	Semiconductor stacked multi-package module having inverted second package
Attorney Docket Number::	CPAC 1029-2
Total Drawing Sheets::	20
Small Entity?::	No

Applicant Information

Applicant Authority Type:	Inventor
Primary Citizenship Country:	US
Status:	Full Capacity
Given Name:	Marcos
Family Name:	Karnezos
City of Residence:	Palo Alto
State or Province of Residence:	CA
Country of Residence:	US
Street of mailing address:	535 Lytton Avenue
City of mailing address:	Palo Alto
State or Province of mailing address:	CA
Country of mailing address:	US
Postal or Zip Code of mailing address:	94301

Initial 10/8/03

Correspondence Information

Correspondence Customer Number:: 22470

Representative Information

Representative Customer Number::	22470	

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Non-Provisional of	60/417,277	October 8, 2002
This Application	Non-Provisional of	60/460,541	April 4, 2003
This Application	Continuation-in-Part of	10/618,933	July 14, 2003
10/618,933	Non-Provisional of	60/460,541	April 4, 2003

Assignee Information

Assignee name:: ChipPAC, Inc.

Street of mailing address:: 47400 Kato Road

City of mailing address:: Fremont

State or Province of mailing address:: CA

Country of mailing address:: US

Postal or Zip Code of mailing address:: 94538